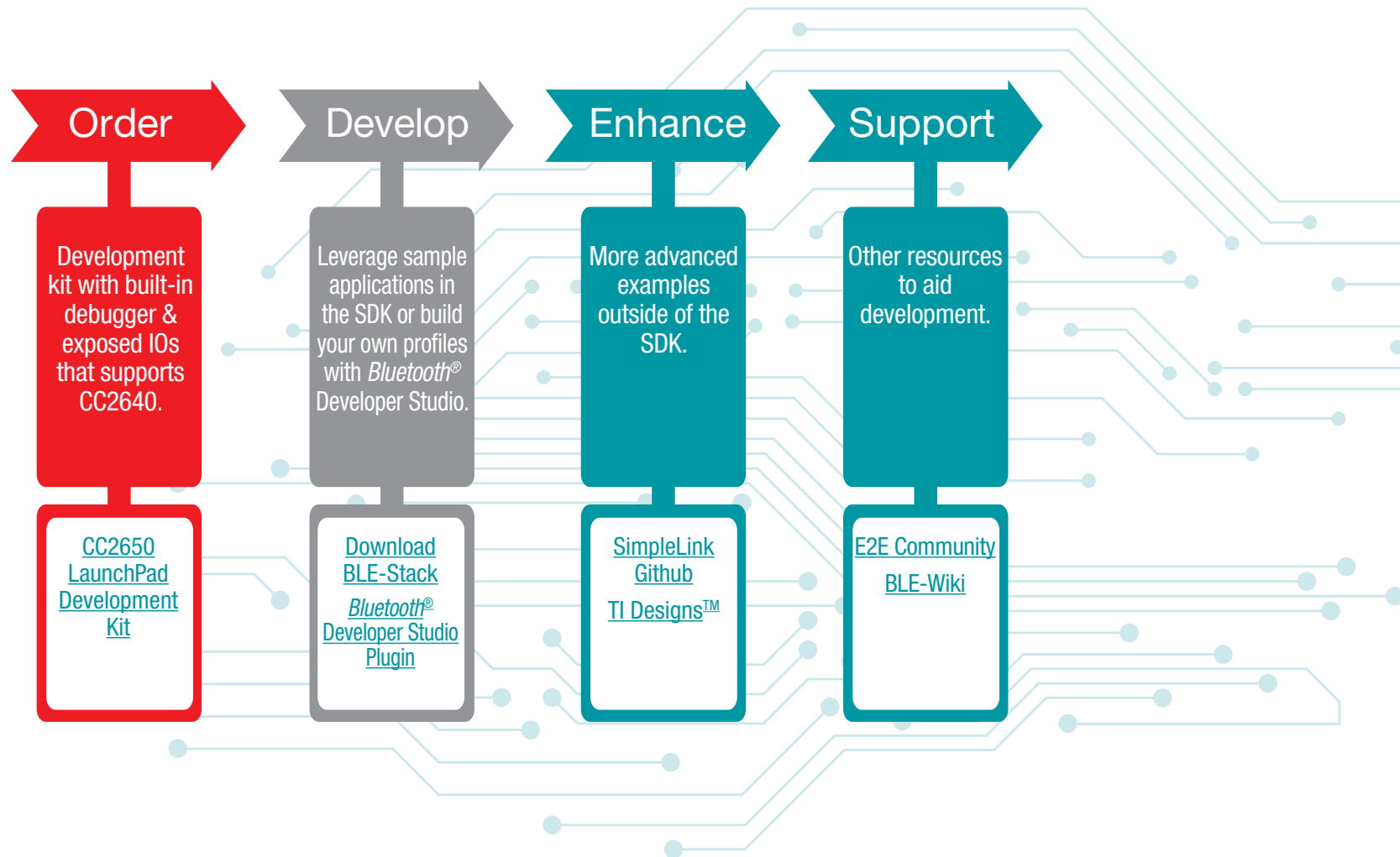


Getting started with *Bluetooth*® low energy CC2640 for IAR users

128 KB of flash, *Bluetooth*® 4.2 compliant



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